

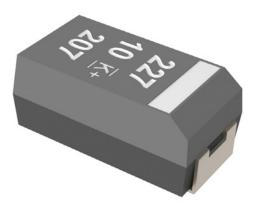
#### **Overview**

The KEMET T499 is a high-temperature product that offers optimum performance characteristics in applications with operating temperatures up to 175°C. Advanced materials and testing allow this series to perform with a reliability level of 0.5%/1000 hours at rated voltage and temperature.

T499 AUTO is classified as having moisture sensitivity level (MSL) 1 under J STD 020: unlimited floorlife time at ≤ 30°C/85% RH. T499 AUTO is available in five standard EIA case sizes, with ROHS-compliant terminations as standard.

#### **Benefits**

- Meets or exceeds EIA Standard 535BAAC
- Tape & Reel standard packaging per EIA 481
- Symmetrical, compliant terminations
- Optional gold-plated terminations
- Laser-marked case
- 100% surge current testing
- Complies with AEC-Q200
- 100% steady-state accelerated aging
- Voltage derating is 1/2 at 175°C



## **Applications**

Typical applications include decoupling and filtering in industrial and automotive end applications, such as DC/DC converters, portable electronics, telecommunications, and control units operating at temperatures up to 175°C.

## **Environmental Compliance**

RoHS compliant (6/6) according to Directive 2002/95/EC when ordered with 100% Sn solder or gold-plated.

- Halogen-free
- Epoxy compliant with UL94 V-0
- Molded Epoxy complies for outgassing testing under ASTM E 595.



#### K-SIM

For a detailed analysis of specific part numbers, please visit ksim.kemet.com to access KEMET's K-SIM software. KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels.

#### **Ordering Information**

Т	499	X	227	М	010	Α	т	E500	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Failure Rate/ Design	Termination Finish	ESR	Packaging (C-Spec)
T = Tantalum	High Temperature 175°C	A B C D X	First two digits represent significant figures. Third digit specifies number of zeros.	K = ±10% M = ±20%	006 = 6.3 010 = 10 016 = 16 020 = 20 025 = 25 035 = 35 050 = 50	A = N/A	T = 100% Matte tin (Sn)-plated G = Gold-plated H = Standard solder coated (SnPb 5% Pb minimum)	E = ESR Last three digits specify ESR in mΩ (500 = 500 mΩ)	Blank = 7" reel 7280 = 13" reel 7027 = Moisture barrier bag

## **Performance Characteristics**

Item	Performance Characteristics
Operating Temperature	-55°C to 175°C
Rated Capacitance Range	0.15 – 220 μF at 120 Hz/25°C
Capacitance Tolerance	K tolerance (10%), M tolerance (20%)
Rated Voltage Range	6 – 50 V
DF (120 Hz)	Refer to Part Number Electrical Specification Table
ESR (100 kHz)	Refer to Part Number Electrical Specification Table
Leakage Current	$\leq$ 0.01 CV (µA) at rated voltage after 5 minutes



## Qualification

Test	Condition			Charact	teristics			
			ΔC/C	Within ±10%	6 of initial valu	e		
Endurance	$175^{\circ}$ C at 1/2 rated valtage 2 000 hours	DF	Within initial limits					
Endurance	175°C at 1/2 rated voltage, 2,000 hours		DCL	Within 1.25 x initial limit				
			ESR	Within initia	al limits			
			ΔC/C	Within ±10%	6 of initial valu	е		
Ctorogo Life	175°C at 0 valta 2 000 haura		DF	Within initia	al limits			
Storage Life	175°C at 0 volts, 2,000 hours		DCL	Within 1.25	x initial limit			
			ESR	Within initia	al limits			
			ΔC/C	Within ±5% of initial value				
Thermal Check	MIL-STD-202, Method 107, Condition B, mo	unted,	DF	Within initial limits				
Thermal Shock	-55°C to 175°C, 1,000 cycles		DCL	Within 1.25	x initial limit			
		ESR	Within initia	al limits				
			+25°C	-55°C	+85°C	+175°C		
Tomporature Stability	Extreme temperature exposure at a succession of continuous steps at +25°C,	ΔC/C	IL*	±10%	±10%	±30%		
Temperature Stability	-55°C, +25°C, +85°C, +175°C, +25°C	DF	IL	IL	1.5 x IL	1.5 x IL		
		DCL	IL	N/A	10 x IL	12 x IL		
			ΔC/C	Within ±5%	of initial value			
Currae Valtage	85°C, 1.32 x rated voltage 1,000 cycles		DF	Within initia	al limits			
Surge Voltage	(150°C, 1.2 x rated voltage)		DCL	Within initia	al limits			
	MIL-STD-202, Method 213, Figure 1, Conditio	n F, 1,500 G	ΔC/C	Within ±10%	6 of initial valu	e		
Mechanical Shock/ Vibration	peak MIL–STD–202, Method 214, 5g for 20 minut	es/12	DF	Within initial limits				
	cycles each of 3 orientations. Test from 10 t		DCL	Within initia	al limits			

\*IL = Initial Limit

## Certification

KEMET's Internal Qualification Plan for this Tantalum series of capacitors follows AEC-Q200 guidelines.



T499B106M010ATE1K8

T499D476M010ATE600

T499X227M010ATE500

1,000,000

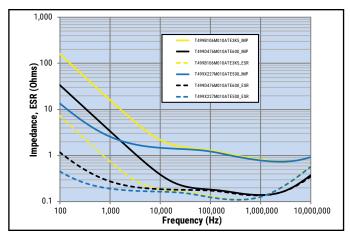
10,000,000

Capacitance vs. Frequency

10,000 100,000 Frequency (Hz)

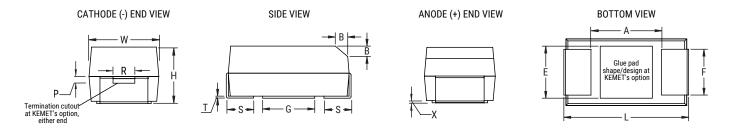
# **Electrical Characteristics**





## **Dimensions – Millimeters (Inches)**

Metric will govern



1,000

100

10

1

0.1

100

1,000

Capacitance (µF)

Case	Size						Comp	onent						
KEMET	EIA	L	W	Н	F ±0.1 ±(0.004)	S ±0.3 ±(0.012)	B ±0.15(Ref) ±0.006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
А	3216-18	3.2±0.2 (0.126±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	1.2 (0.047)	0.8 (0.031)	0.4 (0.016)	0.10±0.10 (0.004±0.004)	0.4 (0.016)	0.4 (0.016)	0.13 (0.005)	1.2 (0.047)	1.1 (0.043)	1.3 (0.051)
В	3528-21	3.5±0.2 (0.138±0.008)	2.8±0.2 (0.110±0.008)	1.9±0.2 (0.075±0.008)	2.2 (0.087)	0.8 (0.031)	0.4 (0.016)	0.10±0.10 (0.004±0.004)	0.5 (0.020)	1.0 (0.039)	0.13 (0.005)	1.9 (0.075)	1.8 (0.071)	2.2 (0.087)
С	6032-28	6.0±0.3 (0.236±0.012)	3.2±0.3 (0.126±0.012)	2.5±0.3 (0.098±0.012)	2.2 (0.087)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	0.9 (0.035)	1.0 (0.039)	0.13 (0.005)	3.1 (0.122)	2.8 (0.110)	2.4 (0.094)
D	7343-31	7.3±0.3 (0.287±0.012)	4.3±0.3 (0.169±0.012)	2.8±0.3 (0.110±0.012)	2.4 (0.094)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	0.9 (0.035)	1.0 (0.039)	0.13 (0.005)	3.8 (0.150)	3.5 (0.138)	3.5 (0.138)
Х	7343-43	7.3±0.3 (0.287±0.012)	4.3±0.3 (0.169±0.012)	4.0±0.3 (0.157±0.012)	2.4 (0.094)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	1.7 (0.067)	1.0 (0.039)	0.13 (0.005)	3.8 (0.150)	3.5 (0.138)	3.5 (0.138)

Notes: (Ref) – Dimensions provided for reference only.



#### Table 1 – Ratings & Part Number Reference

Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR		mum Allo e Curren		Maximum Operating Temp	MSL
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	µA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100 kHz	mA at +85°C 100 kHz	mA at +125°C 100 kHz	°C	Reflow Temp ≤ 260°C
6.3	4.7	A/3216-18	T499A475(1)006A(2)E6K0	0.5	6	6,000	112	101	45	175	1
6.3	6.8	B/3528-21	T499B685(1)006A(2)E3K5	0.5	6 6	3500	156	140.4	62.4	175 175	1
6.3 6.3	10 15	B/3528-21 B/3528-21	T499B106(1)006A(2)E3K5 T499B156(1)006A(2)E3K5	0.6 0.9	6	3,500 3,500	156 156	140 140	62 62	175	1
6.3	22	B/3528-21 B/3528-21	T499B130(1)006A(2)E3K5	1.4	6	3,500	156	140	62	175	1
6.3	22	C/6032-28	T499C226(1)006A(2)E1K8	1.4	6	1,800	247	222	99	175	1
6.3	33	B/3528-21	T499B336(1)006A(2)E3K0	2.1	6	3,000	168	151	67	175	1
6.3	33	C/6032-28	T499C336(1)006A(2)E1K8	2.1	6	1,800	247	222	99	175	1
6.3	47	C/6032-28	T499C476(1)006A(2)E1K8	3.0	6	1,800	247	222	99	175	1
6.3	47	D/7343-31	T499D476(1)006A(2)E800	3.0	6	800	433	390	173	175	1
6.3	68	C/6032-28	T499C686(1)006A(2)E1K2	4.3	6	1,200	303	273	121	175	1
6.3	100	D/7343-31	T499D107(1)006A(2)E800	6.3	8	800	433	390	173	175	1
6.3	150	D/7343-31	T499D157(1)006A(2)E700	9.5	8	700	463	417	185	175	1
10	1.5	A/3216-18	T499A155(1)010A(2)E8K0	0.5	6	8,000	97	87	39	175	1
10	2.2	A/3216-18	T499A225(1)010A(2)E8K0	0.5	6	8,000	97	87	39	175	1
10	3.3	A/3216-18	T499A335(1)010A(2)E6K0	0.5	6	6,000	112	101	45	175	1
10	4.7	A/3216-18	T499A475(1)010A(2)E6K0	0.5	6	6,000	112	101	45	175	1
10	4.7	B/3528-21	T499B475(1)010A(2)E3K5	0.5	6	3,500	156	140	62	175	1
10	6.8 6.8	A/3216-18 B/3528-21	T499A685(1)010A(2)E6K0	0.7 0.7	6 6	6,000	112 156	101 140	45 62	175 175	1 1
10 10	0.8 10	B/3528-21 B/3528-21	T499B685(1)010A(2)E3K5 T499B106(1)010A(2)E3K5	1.0	6	3,500 3,500	156	140	62	175	1
10	10	C/6032-28	T499B100(1)010A(2)E3K5	1.0	6	3,300 1,800	247	222	99	175	1
10	15	B/3528-21	T499B156(1)010A(2)E3K5	1.5	6	3,500	156	140	62	175	1
10	15	C/6032-28	T499C156(1)010A(2)E1K8	1.5	6	1,800	247	222	99	175	1
10	22	B/3528-21	T499B226(1)010A(2)E3K0	2.2	6	3,000	168	151	67	175	1
10	22	C/6032-28	T499C226(1)010A(2)E1K8	2.2	6	1,800	247	222	99	175	1
10	33	C/6032-28	T499C336(1)010A(2)E1K8	3.3	6	1,800	247	222	99	175	1
10	33	D/7343-31	T499D336(1)010A(2)E1K6	3.3	6	1,600	306	275	122	175	1
10	47	D/7343-31	T499D476(1)010A(2)E800	4.7	6	800	433	390	173	175	1
10	68	D/7343-31	T499D686(1)010A(2)E800	6.8	6	800	433	390	173	175	1
10	100	D/7343-31	T499D107(1)010A(2)E700	10.0	8	700	463	417	185	175	1
10	220	X/7343-43	T499X227(1)010A(2)E500	22.0	8	500	574	517	230	175	1
16	1	A/3216-18	T499A105(1)016A(2)E10K	0.5	4	10,000	87	78	35	175	1
16	1.5	A/3216-18	T499A155(1)016A(2)E8K0	0.5	6	8,000	97	87	39	175	1
16	2.2	A/3216-18	T499A225(1)016A(2)E6K0	0.5	6	6,000	112	101	45	175	1
16	3.3	A/3216-18	T499A335(1)016A(2)E6K0	0.5	6	6,000	112	101	45	175	1
16 16	3.3 4.7	B/3528-21 B/3528-21	T499B335(1)016A(2)E3K5 T499B475(1)016A(2)E6K0	0.5 0.8	6 6	3,500	156 119	140 107	62 48	175 175	1 1
16 16	4.7 6.8	A/3216-18	T499B475(1)016A(2)E6K0 T499A685(1)016A(2)E7K0	0.8	6	6,000 7,000	104	107 94	48 42	175	1
16	0.8 6.8	B/3528-21	T499B685(1)016A(2)E7K0	1.1	6	7,000 3,500	104	94 140	42 62	175	1
16	6.8	C/6032-28	T499B085(1)016A(2)E3K5	1.1	6	1,800	247	222	99	175	1
16	10	B/3528-21	T499B106(1)016A(2)E3K5	1.6	6	3,500	156	140	62	175	1
16	10	C/6032-28	T499C106(1)016A(2)E1K8	1.6	6	1,800	247	222	99	175	1
16	15	C/6032-28	T499C156(1)016A(2)E1K8	2.4	6	1,800	247	222	99	175	1
16	22	C/6032-28	T499C226(1)016A(2)E1K6	3.5	6	1,600	262	236	105	175	1
16	22	D/7343-31	T499D226(1)016A(2)E800	3.5	6	800	433	390	173	175	1
16	33	D/7343-31	T499D336(1)016A(2)E800	5.3	6	800	433	390	173	175	1
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	µA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100 kHz	mA at +85°C 100 kHz	mA at +125°C 100 kHz	°C	Reflow Temp ≤ 260°C
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Max	cimum Allov ple Current	wable	Maximum Operating Temp	MSL

(1) To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.
(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum). Designates Termination Finish.

Refer to Ordering Information for additional detail.

Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

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#### Table 1 – Ratings & Part Number Reference cont.

Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Rippl	mum Allo e Curren	t (rms)	Maximum Operating Temp	MSL
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	µA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100 kHz	mA at +85°C 100 kHz	mA at +125°C 100 kHz	°C	Reflow Temp ≤ 260°C
16	47	D/7343-31	T499D476(1)016A(2)E800	7.5	6	800	433	390	173	175	1
16 20	100 0.68	X/7343-43 A/3216-18	T499X107(1)016A(2)E300	16.0 0.5	6 4	300 12,000	742 79	668 71	297 32	175 175	1
20	1	A/3216-18	T499A684(1)020A(2)E12K T499A105(1)020A(2)E10K	0.5	4	12,000	87	78	32	175	1
20	1.5	A/3216-18	T499A155(1)020A(2)E8K0	0.5	6	8,000	97	87	39	175	1
20	2.2	B/3528-21	T499B225(1)020A(2)E3K5	0.5	6	3,500	156	140	62	175	1
20	3.3	B/3528-21	T499B335(1)020A(2)E3K5	0.7	6	3,500	156	140	62	175	1
20	4.7	B/3528-21	T499B475(1)020A(2)E3K5	0.9	6	3,500	156	140	62	175	1
20	4.7	C/6032-28	T499C475(1)020A(2)E2K4	0.9	6	2,400	214	193	86	175	1
20	6.8	C/6032-28	T499C685(1)020A(2)E1K9	1.4	6	1,900	241	217	96	175	1
20	10	C/6032-28	T499C106(1)020A(2)E1K8	2.0	6	1,800	247	222	99	175	1
20	15	C/6032-28	T499C156(1)020A(2)E1K7	3.0	6	1,700	254	229	102	175	1
20 20	15 22	D/7343-31 D/7343-31	T499D156(1)020A(2)E1K0 T499D226(1)020A(2)E800	3.0 4.4	6	1,000 800	387 433	348 390	155 173	175 175	1
20	0.47	A/3216-18	T499D220(1)020A(2)E800	0.5	4	14,000	433	66	29	175	1
25	0.68	A/3216-18	T499A684(1)025A(2)E10K	0.5	4	10,000	87	78	35	175	1
25	1	A/3216-18	T499A105(1)025A(2)E8K0	0.5	4	8,000	97	87	39	175	1
25	1.5	A/3216-18	T499A155(1)025A(2)E5K0	0.5	6	5,000	122	110	49	175	1
25	2.2	B/3528-21	T499B225(1)025A(2)E4K5	0.6	6	4,500	137	123	55	175	1
25	3.3	C/6032-28	T499C335(1)025A(2)E2K5	0.8	6	2,500	210	189	84	175	1
25	4.7	C/6032-28	T499C475(1)025A(2)E2K4	1.2	6	2,400	214	193	86	175	1
25	6.8	C/6032-28	T499C685(1)025A(2)E1K9	1.7	6	1,900	241	217	96	175	1
25	6.8	D/7343-31	T499D685(1)025A(2)E1K1	1.7	6	1,100	369	332	148	175	1
25	10	C/6032-28	T499C106(1)025A(2)E1K5	2.5	6	1,500	271	244	108	175	1
25	10	D/7343-31	T499D106(1)025A(2)E1K0	2.5	6	1,000	387	348	155	175	1
25 25	15 22	D/7343-31 D/7343-31	T499D156(1)025A(2)E1K0	3.8 5.5	6 6	1,000 800	387 433	348 390	155 173	175 175	1
25	33	D/7343-31	T499D226(1)025A(2)E800 T499D336(1)025A(2)E700	8.3	6	700	433	417	175	175	1
35	0.15	A/3216-18	T499A154(1)035A(2)E19K	0.5	4	19,000	63	57	25	175	1
35	0.22	A/3216-18	T499A224(1)035A(2)E18K	0.5	4	18,000	65	59	26	175	1
35	0.33	A/3216-18	T499A334(1)035A(2)E15K	0.5	4	15,000	71	64	28	175	1
35	0.47	B/3528-21	T499B474(1)035A(2)E8K0	0.5	4	8,000	103	93	41	175	1
35	0.68	B/3528-21	T499B684(1)035A(2)E6K5	0.5	4	6,000	119	107	48	175	1
35	1	A/3216-18	T499A105(1)035A(2)E10K	0.5	4	10,000	87	78	35	175	1
35	1	B/3528-21	T499B105(1)035A(2)E5K0	0.5	4	5,000	130	117	52	175	1
35	1.5	C/6032-28	T499C155(1)035A(2)E4K5	0.5	6	4,500	156	140	62	175	1
35	2.2	C/6032-28	T499C225(1)035A(2)E3K5	0.8	6	3,500	177	159	71	175	1
35 35	3.3 4.7	C/6032-28 C/6032-28	T499C335(1)035A(2)E2K5 T499C475(1)035A(2)E2K5	1.2 1.6	6 6	2,500	210 210	189 189	84 84	175 175	1 1
35 35	4.7	D/7343-31	T499D475(1)035A(2)E2K5	1.6	6	2,500 1,500	316	284	84 126	175	1
35	4.7	D/7343-31 D/7343-31	T499D475(1)035A(2)E1K5	1.6	6	1,000	310	348	120	175	1
35	4.7	D/7343-31	T499D475(1)035A(2)E900	1.6	6	900	408	340	163	175	1
35	6.8	D/7343-31	T499D685(1)035A(2)E1K3	2.4	6	1,300	340	306	136	175	1
35	10	D/7343-31	T499D106(1)035A(2)E1K0	3.5	6	1,000	387	348	155	175	1
35	22	X/7343-43	T499X226(1)035A(2)E700	7.7	6	700	486	437	194	175	1
35	33	X/7343-43	T499X336(1)035A(2)E600	11.6	6	600	524	472	210	175	1
50	3.3	D/7343-31	T499D335(1)050A(2)E2K0	1.7	6	2,000	274	247	110	175	1
50	4.7	D/7343-31	T499D475(1)050A(2)E900	2.4	4.5	900	408	367	163	175	1
50	10	D/7343-31	T499D106(1)050A(2)E1K0	5.0	6	1,000	387	348	155	175	1
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	µA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100 kHz	mA at +85°C 100 kHz	mA at +125°C 100 kHz	°C	Reflow Temp ≤ 260°C
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	Max	cimum Allov ple Current	wable	Maximum Operating Temp	MSL

(1) To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.

(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum). Designates Termination Finish.

Refer to Ordering Information for additional detail.

Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

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#### **Recommended Voltage Derating Guidelines**

Rated Voltage	Working	) Voltage	Application	mended Voltage (for reliability)	100%		% Change in Working	g DC		
	85°C	175°C	85°C	175°C	Voltage <sup>%08</sup>		Voltage with Temper			
6.3	6.3	3.15	3.15	1.58	א ני <sup>60%</sup>					
10	10	5.00	5	2.50	00% Morking 40%					50%
16	16	8.00	8	4.00	<b>Š</b> 40%		Recommended Maxi	imum		50%
20	20	10.00	10	5.00	%		Application Voltage (As % of Rated Volta			
25	25	12.50	12.5	6.25	20%		(AS % OF Rated Volta	iye)		25%
35	35	17.50	17.5	8.75						
50	50	25.00	25	12.50	0% <sup> </sup> -5	55	25	85	125	175
								mperatur		

#### **Ripple Current/Ripple Voltage**

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

1. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.

2. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage. See the Reverse Voltage section for allowable limits.

The maximum power dissipation by case size can be determined using the table at right. The maximum power dissipation rating stated in the table must be reduced with increasing environmental operating temperatures. Refer to the table below for temperature compensation requirements.

Temp	Temperature Compensation Multipliers for Maximum Ripple Current										
T ≤ 25°C	T ≤ 85°C	T ≤ 125°C	T ≤ 175°C								
1.00	1.00 0.90 0.40 0.20										

T= Environmental Temperature

The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.

KEMET Series and Case Code	EIA Case Code	Maximum Power Dissipation (P max) mWatts at 25°C with +20°C Rise
A	3216-18	75
В	3528-21	85
С	6032-28	110
D	7343-31	150
Х	7343-43	165
E	7360-38	200
S	3216-12	60
Т	3528-12	70
U	6032-15	90
V	7343-20	125
T510X	7343-43	270
T510E	7360-38	285

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

 $I(max) = \sqrt{P max/R}$  $E(max) = Z \sqrt{P max/R}$ 

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

*P* max = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Z = Impedance at specified frequency (ohms)



#### **Reverse Voltage**

Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the table. The capacitors should not be operated continuously in reverse mode, even within these limits.

Temperature	Permissible Transient Reverse Voltage					
25°C	15% of Rated Voltage					
85°C	5% of Rated Voltage					
125°C	1% of Rated Voltage					

#### Table 2 – Land Dimensions/Courtyard

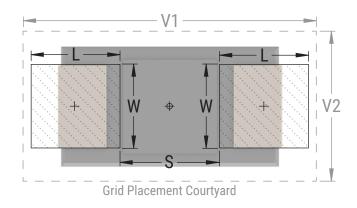
KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)				
Case	EIA	W	L	S	V1	V2	W	L	S	V1	V2	W	L	S	V1	V2
А	3216-18	1.35	2.20	0.62	6.02	2.80	1.23	1.80	0.82	4.92	2.30	1.13	1.42	0.98	4.06	2.04
В	3528-21	2.35	2.21	0.92	6.32	4.00	2.23	1.80	1.12	5.22	3.50	2.13	1.42	1.28	4.36	3.24
С	6032-28	2.35	2.77	2.37	8.92	4.50	2.23	2.37	2.57	7.82	4.00	2.13	1.99	2.73	6.96	3.74
D	7343-31	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84
<b>X</b> <sup>1</sup>	7343-43	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC–7351).

<sup>1</sup> Height of these chips may create problems in wave soldering.

<sup>2</sup> Land pattern geometry is too small for silkscreen outline.



## **Soldering Process**

The KEMET families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

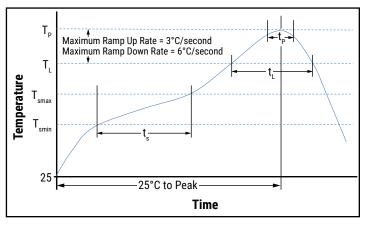
Please note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. "Wiping" the edges of a chip and heating the top surface is not recommended.

During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

Profile Feature	SnPb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Minimum $(T_{Smin})$	100°C	150°C
Temperature Maximum (T <sub>Smax</sub> )	150°C	200°C
Time ( $t_s$ ) from $T_{smin}$ to $T_{smax}$ )	60 – 120 seconds	60 – 120 seconds
Ramp-up Rate ( $T_L$ to $T_P$ )	3°C/second maximum	3°C/second maximum
Liquidous Temperature $(T_L)$	183°C	217°C
Time Above Liquidous (t <sub>L</sub> )	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T <sub>P</sub> )	220°C* 235°C**	250°C* 260°C**
Time within 5°C of Maximum Peak Temperature (t <sub>P</sub> )	20 seconds maximum	30 seconds maximum
Ramp-down Rate $(T_P to T_L)$	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow. \* For Case Size height > 2.5 mm \*\* For Case Size height ≤ 2.5 mm

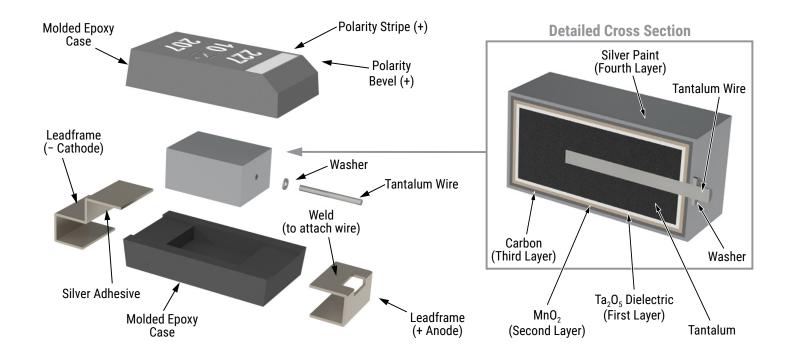


#### Storage

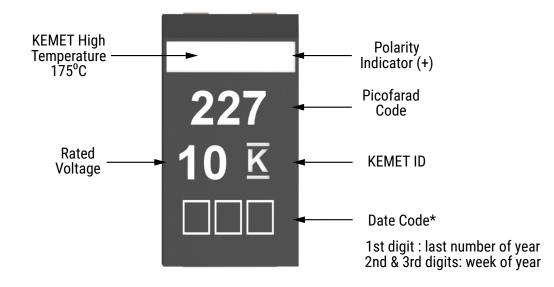
Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within three years of receipt.



## Construction



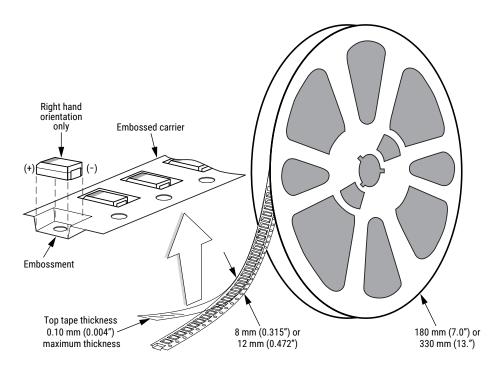
**Capacitor Marking** 





#### **Tape & Reel Packaging Information**

KEMET's molded chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with *EIA Standard 481*: Embossed Carrier Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape-fed automatic pick-and-place systems.



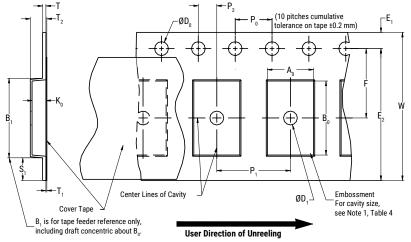
## Table 3 – Packaging Quantity

Case Code		Tape Width (mm)	7" Reel*	13" Reel*	
KEMET	EIA				
S	3216-12	8	2,500	10,000	
Т	3528-12	8	2,500	10,000	
М	3528-15	8	2,500	8,000	
U	6032-15	12	1,000	5,000	
L	6032-19	12	1,000	3,000	
W	7343-15	12	1,000	3,000	
Z	7343-17	12	1,000	3,000	
V	7343-20	12	1,000	3,000	
Α	3216-18	8	2,000	9,000	
В	3528-21	8	2,000	8,000	
С	6032-28	12	500	3,000	
D	7343-31	12	500	2,500	
Q	7343-12	12	1,000	3,000	
Y	7343-40	12	500	2,000	
Х	7343-43	12	500	2,000	
E/T428P	7360-38	12	500	2,000	
Н	7360-20	12	1,000	2,500	
0	7360-43	12	250	1,000	

\* No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.



## Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



## Table 4 – Embossed (Plastic) Carrier Tape Dimensions

#### Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	D <sub>0</sub>	D <sub>1</sub> Minimum Note 1	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	R Reference Note 2	S <sub>1</sub> Minimum Note 3	T Maximum	T <sub>1</sub> Maximum
8 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.0 (0.039)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12 mm		1.5 (0.059)				30 (1.181)			

	Variable Dimensions – Millimeters (Inches)									
Tape Size	Pitch	B <sub>1</sub> Maximum Note 4	E <sub>2</sub> Minimum	F	P <sub>1</sub>	T <sub>2</sub> Maximum	W Maximum	A <sub>0</sub> , B <sub>0</sub> & K <sub>0</sub>		
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)			
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Note 5		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

2. The tape, with or without components, shall pass around R without damage (see Figure 4).

3. If  $S_1 < 1.0$  mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481–D, paragraph 4.3, section b).

4. B, dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by  $A_{\alpha}$ ,  $B_{\alpha}$  and  $K_{\alpha}$  shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes (see Figure 2).

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape (see Figure 3).

(e) see Addendum in EIA Standard 481–D for standards relating to more precise taping requirements.



#### **Packaging Information Performance Notes**

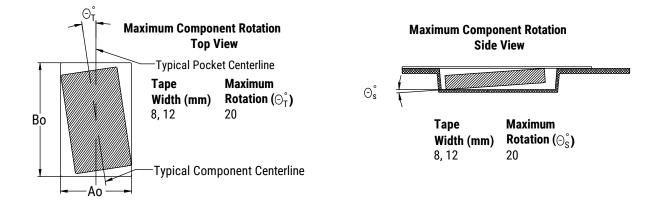
- 1. Cover tape break force: 1.0 kg minimum.
- 2. Cover tape peel strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength		
8 mm	0.1 to 1.0 newton (10 to 100 gf)		
12 mm	0.1 to 1.3 newton (10 to 130 gf)		

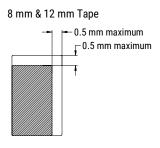
The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be  $165^{\circ}$  to  $180^{\circ}$  from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of  $300 \pm 10$  mm/minute.

**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

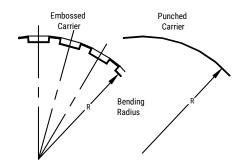
#### Figure 2 – Maximum Component Rotation



## Figure 3 – Maximum Lateral Movement

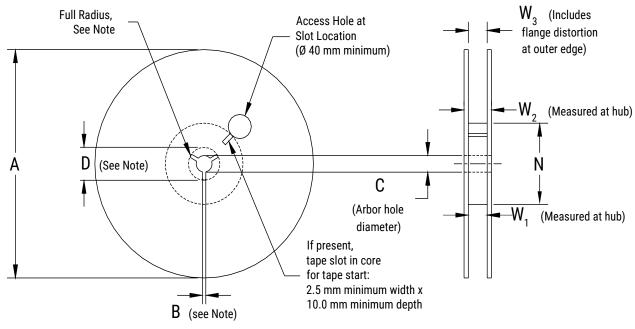


## Figure 4 – Bending Radius





## Figure 5 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

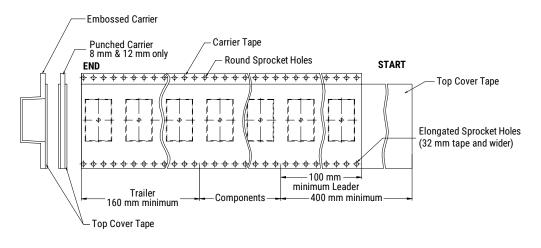
## Table 5 – Reel Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	А	B Minimum	С	D Minimum					
8 mm	178 ±0.20 (7.008 ±0.008)								
12 mm	or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)					
	Variable Dimensions – Millimeters (Inches)								
Tape Size	N Minimum	W <sub>1</sub>	W <sub>2</sub> Maximum	W <sub>3</sub>					
8 mm	50	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape					
12 mm	(1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	width without interference					



## Figure 6 – Tape Leader & Trailer Dimensions



# Figure 7 – Maximum Camber





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